

## **NCE N-Channel Super Trench Power MOSFET**

### (Primary Version)

### **Description**

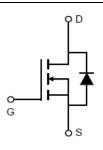
The NCEP0160AG uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{\text{DS(ON)}}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

#### **General Features**

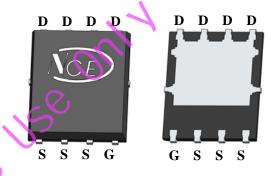
- V<sub>DS</sub> =100V,I<sub>D</sub> =60A
  - $R_{DS(ON)}$  <8.8m $\Omega$  @  $V_{GS}$ =10V
  - $R_{DS(ON)}$  <11.5m $\Omega$  @  $V_{GS}$ =4.5V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

### **Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Schematic Diagram



**Top View** 

**Bottom View** 

100% UIS TESTED!

100% AVds TESTED!

### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP0160AG	NCEP0160AG	DFN5X6-8L	-	-	-

### Absolute Maximum Ratings (T<sub>c</sub>=25°Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous (Package Limited)	I <sub>D</sub>	60	Α
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100℃)	42.5	Α
Pulsed Drain Current	I <sub>DM</sub>	240	А
Maximum Power Dissipation	P <sub>D</sub>	105	W
Derating factor		0.84	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	250	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}$

### Thermal Characteristic

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>θJC</sub>	1.2	°C/W
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# NCEP0160AG

# Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	100		-	V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	-	-	1	μA	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA	
On Characteristics (Note 3)	On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	1.0	1.7	2.2	V	
Drain-Source On-State Resistance	Б	V <sub>GS</sub> =10V, I <sub>D</sub> =30A	-	8	8.8	mΩ	
Diditi-Source Off-State Resistance	$R_{DS(ON)}$	V <sub>GS</sub> =4.5V, I <sub>D</sub> =30A	-	9.2	11.5		
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =10V,I <sub>D</sub> =30A	40	-	-	S	
Dynamic Characteristics (Note4)			/ /				
Input Capacitance	C <sub>lss</sub>	V -50V/V -0V	-	4200	-	PF	
Output Capacitance	Coss	V <sub>DS</sub> =50V,V <sub>GS</sub> =0V, F=1.0MHz	-	354	-	PF	
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UIVIDZ	-	23	-	PF	
Switching Characteristics (Note 4)		150					
Turn-on Delay Time	t <sub>d(on)</sub>	$\sqrt{2}$	-	14	-	nS	
Turn-on Rise Time	t <sub>r</sub>	V <sub>DD</sub> =50V,I <sub>D</sub> =30A	-	9	-	nS	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD}$ =50V, $I_{D}$ =30A $V_{GS}$ =10V, $R_{G}$ =4.7 $\Omega$	-	39	-	nS	
Turn-Off Fall Time	t <sub>f</sub>		-	5	-	nS	
Total Gate Charge	$Q_g$	V -50VI -20A	-	58		nC	
Gate-Source Charge	Qgs	$V_{DS}$ =50V, $I_D$ =30A, $V_{GS}$ =10V	-	12		nC	
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =10V	-	7.8		nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	$V_{SD}$	V <sub>GS</sub> =0V,I <sub>S</sub> =60A	-		1.2	V	
Diode Forward Current (Note 2)	Is		-	-	60	Α	
Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25^{\circ}C$ , $I_F = I_S$	-	58		nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/μs <sup>(Note3)</sup>	-	110		nC	

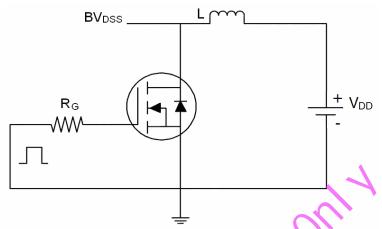
### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25  $^{\circ}\text{C}$  ,V\_DD=50V,V\_G=10V,L=0.5mH,Rg=25 $\Omega$

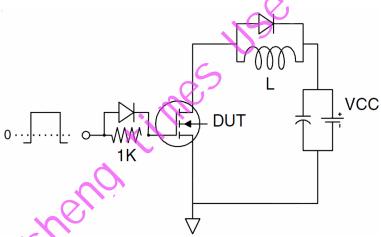


### **Test Circuit**

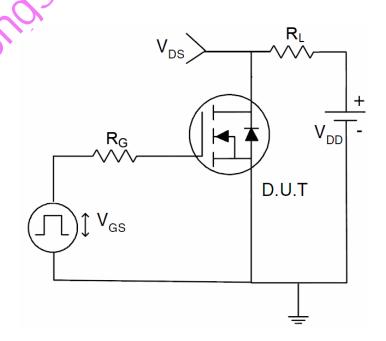
## 1) E<sub>AS</sub> test Circuit



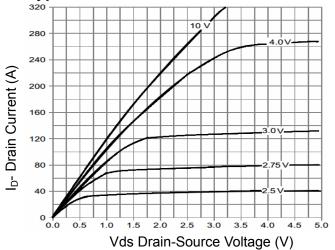
### 2) Gate charge test Circuit



## 3) Switch Time Test Circuit



## **Typical Electrical and Thermal Characteristics**



**Figure 1 Output Characteristics** 

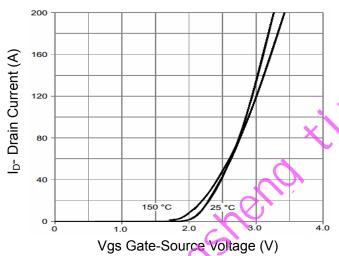


Figure 2 Transfer Characteristics

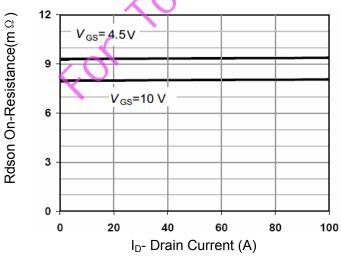


Figure 3 Rdson- Drain Current

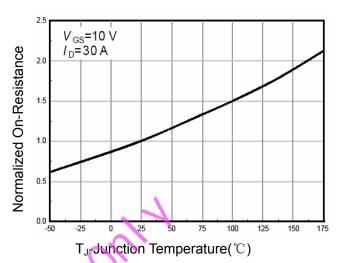


Figure 4 Rdson-JunctionTemperature

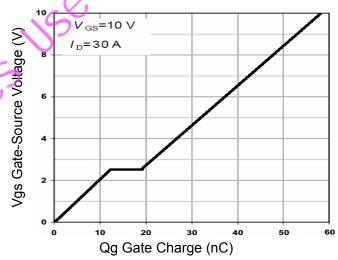


Figure 5 Gate Charge

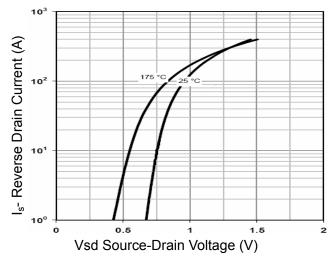
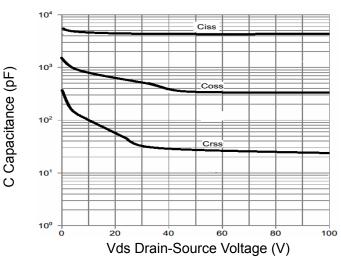


Figure 6 Source- Drain Diode Forward





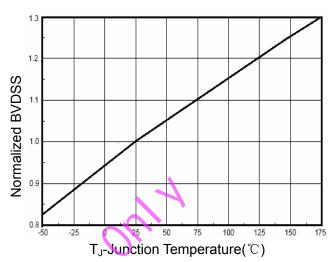


Figure 7 Capacitance vs Vds

Figure 9 BV<sub>DSS</sub> vs Junction Temperature

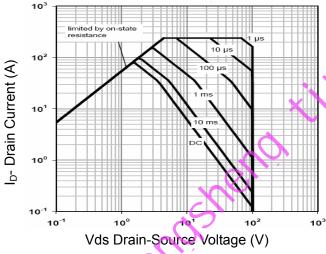


Figure 8 Safe Operation Area

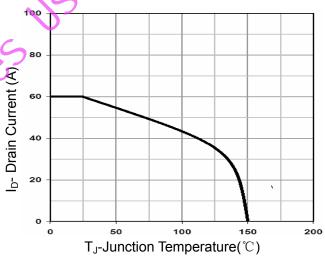
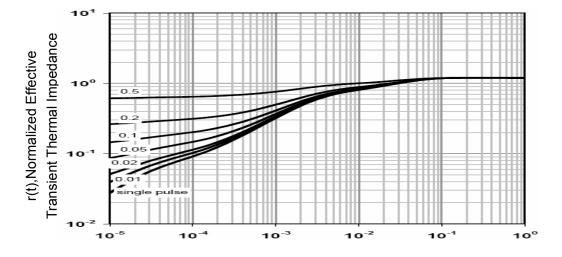


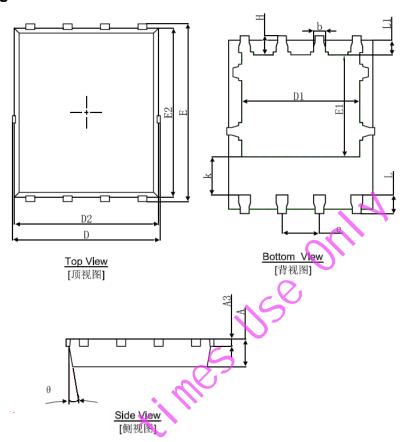
Figure 10 Current De-rating



Square Wave Pluse Duration(sec)

**Figure 11 Normalized Maximum Transient Thermal Impedance** 

## **DFN5X6-8L Package Information**



Dimension In Millimaters Dimensions In Inches						
Symbol	Dimensions In Millimeters		Dimensions In Inches			
- Cy	Min.	Max.	Min.	Max.		
Α	0.900	1.000	0.035	0.039		
A3	0.254	REF.	0.010REF.			
D	4.944	5.096	0.195	0.201		
E	5.974	6.126	0.235	0.241		
D1 _	3.910	4.110	0.154	0.162		
E1	3.375	3.575	0.133	0.141		
D2	4.824	4.976	0.190	0.196		
E2	5.674	5.826	0.223	0.229		
k	1.190	1.390	0.047	0.055		
b	0.350	0.450	0.014	0.018		
е	1.270TYP.		0.050TYP.			
L	0.559	0.711	0.022	0.028		
L1	0.424	0.576	0.017	0.023		
Н	0.574	0.726	0.023	0.029		
θ	8°	12°	8°	12°		



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